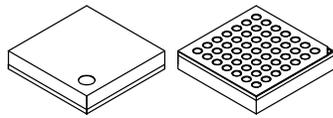


# MECHANICAL CASE OUTLINE

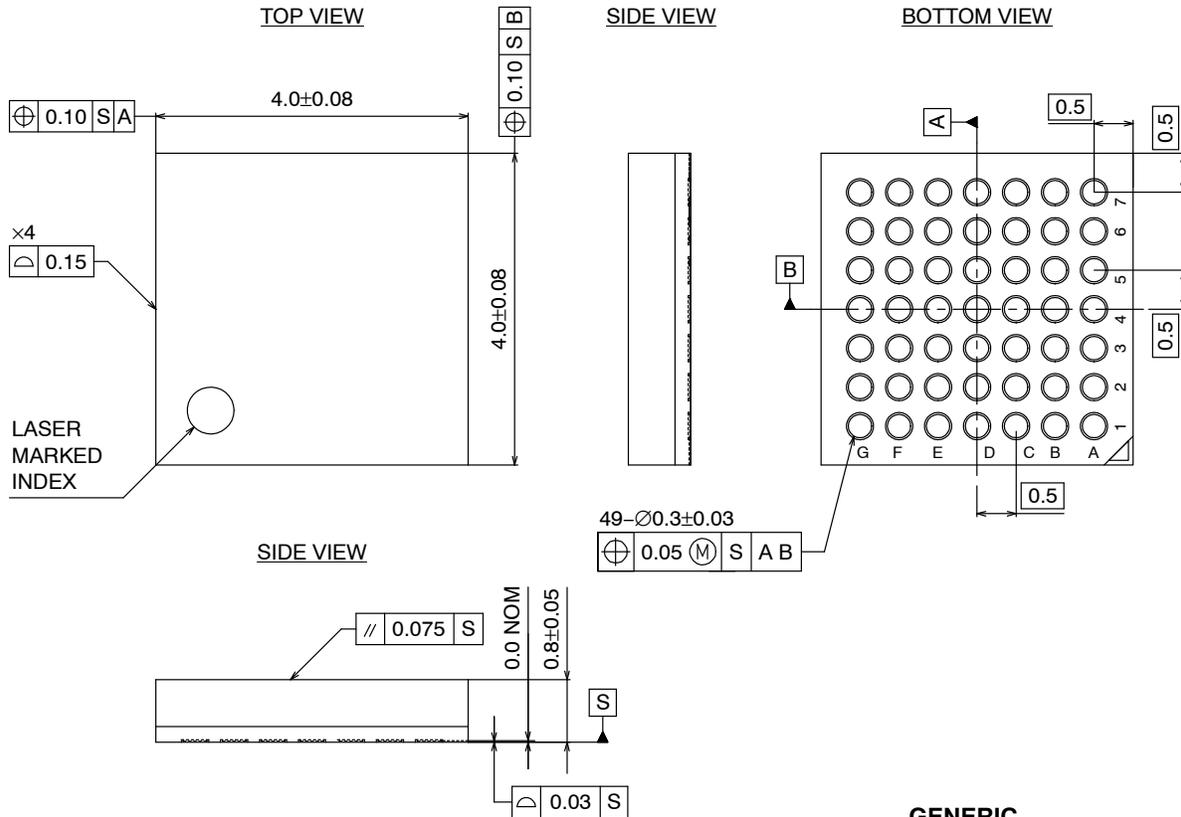
## PACKAGE DIMENSIONS

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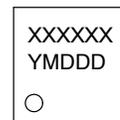


LFLGA49 4x4 / FLGA49  
CASE 569AM  
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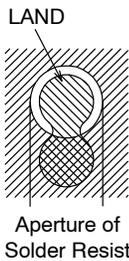
### GENERIC MARKING DIAGRAM\*



XXXXXX = Specific Device Code  
 Y = Year  
 M = Month  
 DDD = Additional Traceability Data

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present.

NSMD  
Off set Via type

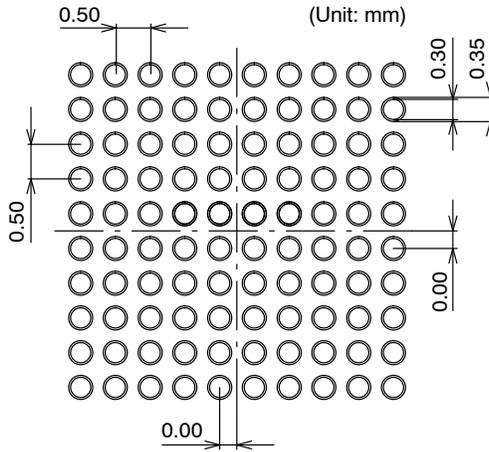


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**SOLDERING FOOTPRINT\***



NOTE: The measurements are not to guarantee but for reference only.

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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<b>NEW STANDARD:</b>		
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